



DGD2136

#### Description

The DGD2136 is a three-phase gate driver IC designed for highvoltage/high-speed applications, driving N-channel MOSFETs and IGBTs in a half-bridge configuration. High-voltage processing techniques enable the DGD2136's high side to switch to 600V in a bootstrap operation.

The DGD2136 logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) for easy interfacing with controlling devices and are enabled low to better function in high-noise environments. The driver outputs feature high-pulse current buffers designed for minimum driver cross conduction.

The DGD2136 offers numerous protection functions. A shoot-through protection logic prevents both outputs from being high when both inputs are high (fault state), an undervoltage lockout for VCC shuts down the respective high side output. An overcurrent protection will terminate the six outputs. Both the VCC UVLO and the overcurrent protection trip an automatic fault clear with a timing that is adjustable with an external capacitor.

The DGD2136 is offered in SO-28 package and the operating temperature extends from -40°C to +125°C.

#### Applications

- 3-Phase Motor Inverter Driver
- White Goods—Air Conditioner, Washing Machine, Refrigerator
- Industrial Motor Inverter—Power Tools, Robotics
- General Purpose 3-Phase Inverter

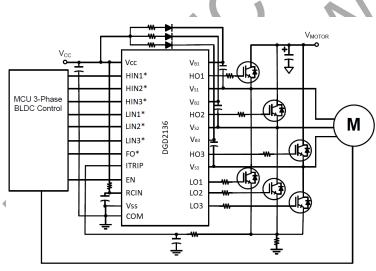
#### 3-PHASE HALF-BRIDGE GATE DRIVER IN SO-28

#### Features

- Three Floating High-Side Drivers in Bootstrap Operation to 600V
- 200mA Source / 350mA Sink Output Current Capability
- Outputs Tolerant to Negative Transients, dV/dt Immune
- Logic Input 3.3V Capability
- Internal Deadtime of 290ns to Protect MOSFETs
- Matched Prop Delay for All Channels
- Outputs Out of Phase with Inputs
- Schmitt Triggered Logic Inputs
- Cross Conduction Prevention Logic
- Undervoltage Lockout for All Channels
- Overcurrent Protection Shuts Down Drivers
- Extended Temperature Range: -40°C to +125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.
- https://www.diodes.com/quality/product-definitions/

#### Mechanical Data

- Case: SO-28 (Type TH)
- Case Material: Molded Plastic. "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 <sup>(63)</sup>
- Weight: 0.250 grams (Approximate)





SO-28 Top View

Typical Configuration

# Ordering Information (Note 4)

Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DGD2136S28-13	DGD2136	13	24	1500

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

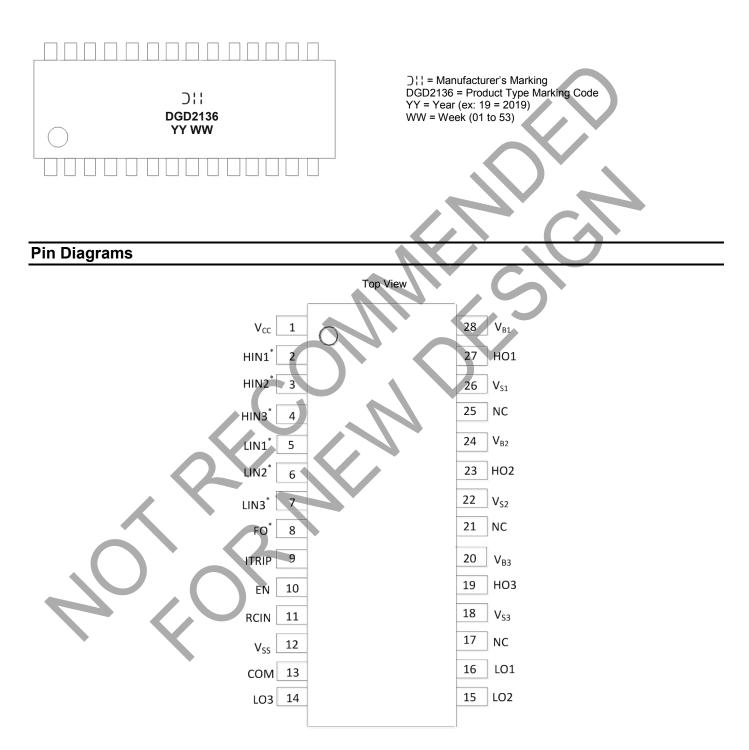
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Notes:



# **Marking Information**



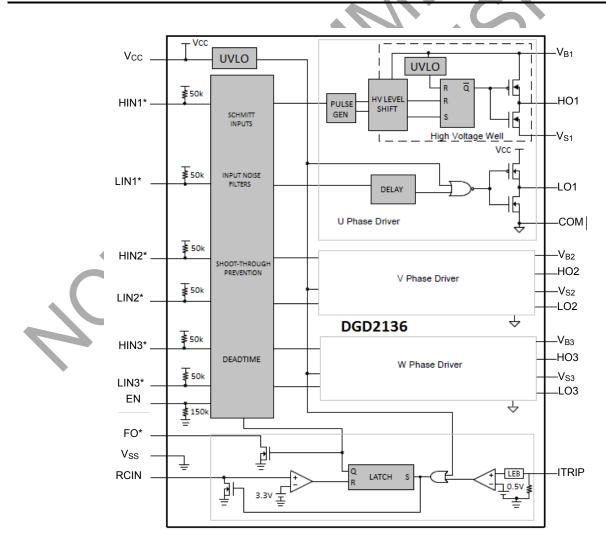
SO-28



# **Pin Descriptions**

Pin Number	Pin Name	Function	
1	V <sub>CC</sub>	Low-Side and Logic Fixed Supply	
2,3,4	HIN1*,HIN2*,HIN3*	Logic Input for High-Side Gate Driver Output, Out of Phase with HO	
5,6,7	LIN1*,LIN2*,LIN3*	Logic Input for Low-Side Gate Driver Output, Out of Phase with LO	
8	FO*	Fault Output with Open Drain (Fault with Overcurrent and V <sub>CC</sub> UVLO)	
9	ITRIP	Analog Input for Overcurrent Shutdown	
10	EN	Logic Input for Functionality, I/O Logic Functions when EN is High	
11	RCIN	An External RC Network Input used to Define FAULT CLEAR Delay	
12	V <sub>SS</sub>	Logic Ground	
13	COM	Low-Side Driver Return	
14,15,16	LO3,LO2,LO1	Low-Side Gate Driver Output	
17,21,25	NC	No Connection (No Internal Connection)	
18,22,26	V <sub>S3</sub> , V <sub>S2</sub> , V <sub>S1</sub>	High-Side Floating Supply Return	
19,23,27	HO3,HO2,HO1	High-Side Gate Driver Output	
20,24,28	V <sub>B3</sub> , V <sub>B2</sub> , V <sub>B1</sub>	High-Side Floating Supply	

# **Functional Block Diagram**





# Absolute Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-Side Floating Supply Voltage	VB	-0.3 to +624	V
High-Side Floating Supply Offset Voltage	Vs	V <sub>B</sub> -24 to V <sub>B</sub> +0.3	V
High-Side Floating Output Voltage	V <sub>HO</sub>	V <sub>S</sub> -0.3 to V <sub>B</sub> +0.3	V
Low-Side Output Voltage	V <sub>LO</sub>	-0.3 to V <sub>CC</sub> +0.3	V
Offset Supply Voltage Transient	dV <sub>S</sub> / dt	50	V/ns
Low-Side Fixed Supply Voltage	Vcc	-0.3 to +24	V
Logic Input Voltage (HIN*, LIN*, ITRIP, EN and FO*)	V <sub>IN</sub>	-0.3 to +5.5	V

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 5)	PD	2.3	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>0JA</sub>	60	°C/W
Thermal Resistance, Junction to Case (Note 5)	R <sub>ejc</sub>	45	°C/W
Operating Temperature	τJ	+150	
Lead Temperature (Soldering, 10s)	TL	+300	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	1

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

# Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
High-Side Floating Supply Absolute Voltage	VB	V <sub>S</sub> + 10	V <sub>S</sub> + 20	V
High-Side Floating Supply Offset Voltage	Vs	(Note 6)	600	V
High-Side Floating Output Voltage	V <sub>HO</sub>	Vs	VB	V
Low-Side Fixed Supply Voltage	Vcc	10	20	V
Low-Side Output Voltage	VLO	COM	Vcc	V
Logic Input Voltage (HIN*, LIN*, ITRIP & EN)	V <sub>IN</sub>	V <sub>SS</sub>	5	V
Fault Output Voltage	V <sub>FO</sub>	V <sub>SS</sub>	Vcc	V
Logic Ground	V <sub>SS</sub>	-5	5	V
Ambient Temperature	T <sub>A</sub>	-40	+125	°C

Note: 6. Logic operation for V<sub>S</sub> of -5V to +600V.



# DC Electrical Characteristics (V<sub>BIAS</sub> (V<sub>CC</sub>, V<sub>BS</sub>) = 15V, @T<sub>A</sub> = +25°C, unless otherwise specified.) (Note 7)

Parameter	Symbol	Min	Тур	Max	Unit	Condition
Logic "0" Input Voltage (Note 8)	VIH	2.4	-	-	V	_
Logic "1" Input Voltage (Note 8)	V <sub>IL</sub>	_	-	0.8	V	_
High Level Output Voltage, V <sub>BIAS</sub> - V <sub>O</sub>	V <sub>OH</sub>	_	-	0.1	V	I <sub>O</sub> = 0mA
Low Level Output Voltage, V <sub>O</sub>	V <sub>OL</sub>	-	-	0.1	V	I <sub>O</sub> = 0mA
Offset Supply Leakage Current	I <sub>LK</sub>	_	Ι	10	μA	$V_{\rm B} = V_{\rm S} = 600 V$
Quiescent V <sub>BS</sub> Supply Current	I <sub>BSQ</sub>	10	85	130	μA	V <sub>IN</sub> = 0V or 5V, EN = 0V
Quiescent V <sub>CC</sub> Supply Current	I <sub>CCQ</sub>	_	1.1	1.6	mA	V <sub>IN</sub> = 0V or 5V, EN = 0V
Logic Input Bias Current (HO=LO=HIGH)	I <sub>IN+</sub>	_	130	200	μA	$V_{IN} = 0V$
Logic Input Bias Current (HO=LO=LOW)	I <sub>IN-</sub>	-	3.0	20	μA	V <sub>IN</sub> = 5V
Logic Enable "1" Input Bias Current	I <sub>EN+</sub>	_	33	80	μA	V <sub>EN</sub> = 5V
Logic Enable "0" Input Bias Current	I <sub>EN-</sub>	-	-	2.0	μA	V <sub>EN</sub> = 0V
V <sub>BS</sub> Supply Undervoltage Positive Going Threshold	V <sub>BSUV+</sub>	7.6	8.9	9.9	V	-
V <sub>BS</sub> Supply Undervoltage Negative Going Threshold	V <sub>BSUV-</sub>	7.1	8.3	9.4	V	
V <sub>CC</sub> Supply Undervoltage Positive Going Threshold	V <sub>CCUV+</sub>	7.6	8.9	9.9	V	
V <sub>CC</sub> Supply Undervoltage Negative Going Threshold	Vccuv-	7.1	8.3	9.4	V	
Output High Short Circuit Pulsed Current	I <sub>O+</sub>	120	200	-	mA	Vo = 0V, PW ≤ 10µs
Output Low Short Circuit Pulsed Current	I <sub>O-</sub>	250	350	-	mA	V <sub>O</sub> = 15V, PW ≤ 10µs
Overcurrent Detect Positive Threshold	VITH+	400	500	600	mV	_
Overcurrent Detect Negative Threshold	V <sub>ITH-</sub>	340	420	500	mV	—
Short-Circuit Input Current	I <sub>CSIN</sub>	6.0	11	16	μA	V <sub>CSIN</sub> = 1V
RCIN Positive Going Threshold Voltage	V <sub>RCINTH+</sub>	7.0	8.4	9.8	V	-
RCIN Negative Going Threshold Voltage	V <sub>RCINTH-</sub>	-	5.0		V	-
Fault Output Low Level Voltage	VFOL		0.2	0.5	V	V <sub>CS</sub> = 1V, I <sub>FO</sub> = 1.5mA
RCIN on Resistance	R <sub>DSRCIN</sub>	40	75	110	Ω	I <sub>RCIN</sub> = 1.5mA
Fault Output on Resistance	R <sub>DSFO</sub>	80	130	180	Ω	I <sub>FO</sub> = 1.5mA

Notes: 7. The V<sub>IN</sub>, V<sub>TH</sub> and I<sub>IN</sub> parameters are referenced to V<sub>SS</sub> and are applicable to all six channels (HIN1\*, 2\*, 3\* and LIN1\*, 2\*, 3\*). The V<sub>O</sub> and I<sub>O</sub> parameters are applicable to the output pins (HO1, 2, 3 and LO1, 2, 3) and are referenced to COM. 8. For optimal operation, it is recommended that the input pulses (HIN1\*, 2\*, 3\* and LIN1\*, 2\*, 3\*) should have a minimum amplitude of 2.4V with a

8. For optimal operation, it is recommended that the input pulses (HIN1\*, 2\*, 3\* and LIN1\*, 2\*, 3\*) should have a minimum amplitude of 2.4V with a minimum pulse width of 600ns.

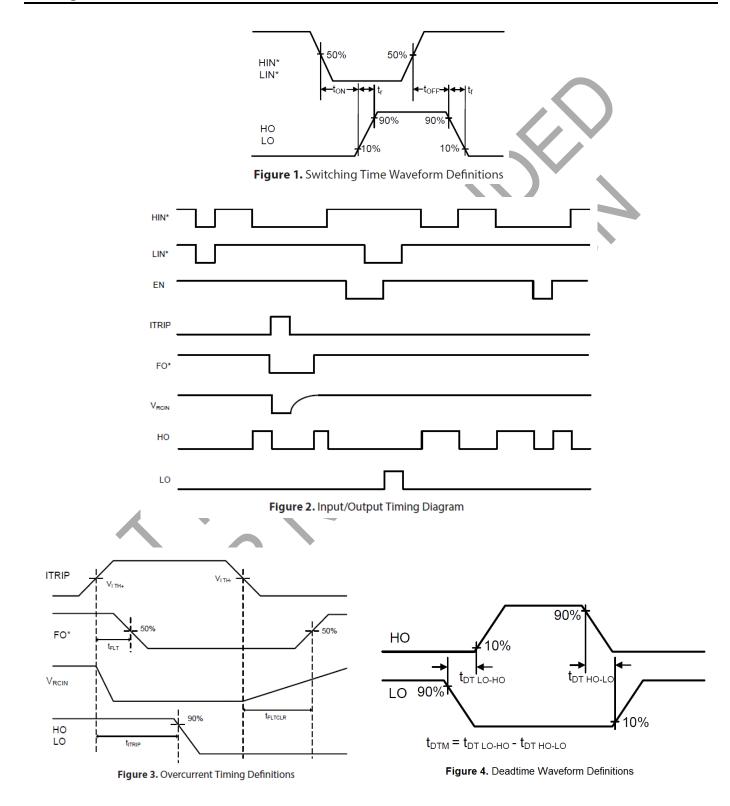
# AC Electrical Characteristics (V<sub>BIAS</sub> (V<sub>CC</sub>, V<sub>BS</sub>) = 15V, C<sub>L</sub> = 1000pF, @T<sub>A</sub> = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Тур	Max	Unit	Condition
Turn-On Propagation Delay	t <sub>ON</sub>	200	330	460	ns	V <sub>S</sub> = 0V
Turn-Off Propagation Delay	t <sub>OFF</sub>	200	330	460	ns	V <sub>S</sub> = 0V
Turn-On Rise Time	t <sub>R</sub>	_	90	150	ns	V <sub>S</sub> = 0V
Turn-Off Fall Time	t <sub>F</sub>	-	35	60	ns	V <sub>S</sub> = 0V
Delay Matching	t <sub>DM</sub>	-	-	50	ns	—
Enable Low to Output Shutdown Delay	t <sub>EN</sub>	225	300	425	ns	—
ITRIP Pin Leading-Edge Blanking Time	t <sub>BLT</sub>	200	300	400	ns	—
Time from ITRIP Triggering to FO*	t <sub>FLT</sub>	360	550	760	ns	From V <sub>ITRIP</sub> = 1V to FO* turn off
Time from ITRIP Triggering to All Gate Outputs Turn Off	titrip	420	615	820	ns	From V <sub>ITRIP</sub> = 1V to starting gate turn off
Input Filtering Time (HIN*, LIN*, EN)	t <sub>FLTIN</sub>	-	250	-	ns	-
Fault Clear Time	<b>t</b> FLTCLR	-	1.6	-	ms	$C_{RCIN} = 1nF,$ $R_{RCIN} = 2M\Omega$
Deadtime	t <sub>DT</sub>	200	290	420	ns	-
Deadtime Matching	t <sub>DTM</sub>	_	-	50	ns	-
Output Pulse Width Matching (Note 8)	t <sub>PM</sub>	_	50	75	ns	PW <sub>IN</sub> > 1µs

Note: 8. tPM is defined as PWIN – PWOUT.



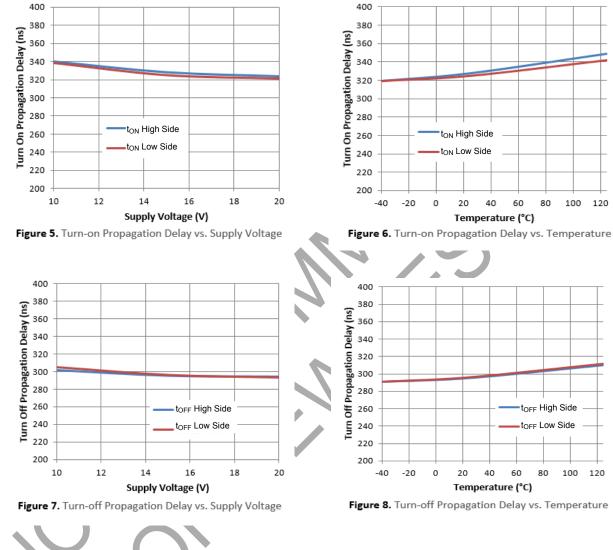
# **Timing Waveforms**

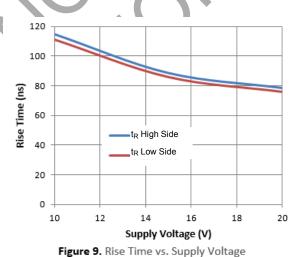


120

120

# Typical Performance Characteristics (Vcc=15V, @TA = +25°C, unless otherwise specified.)





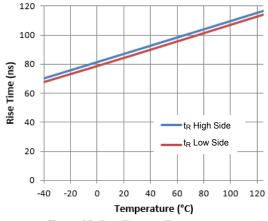
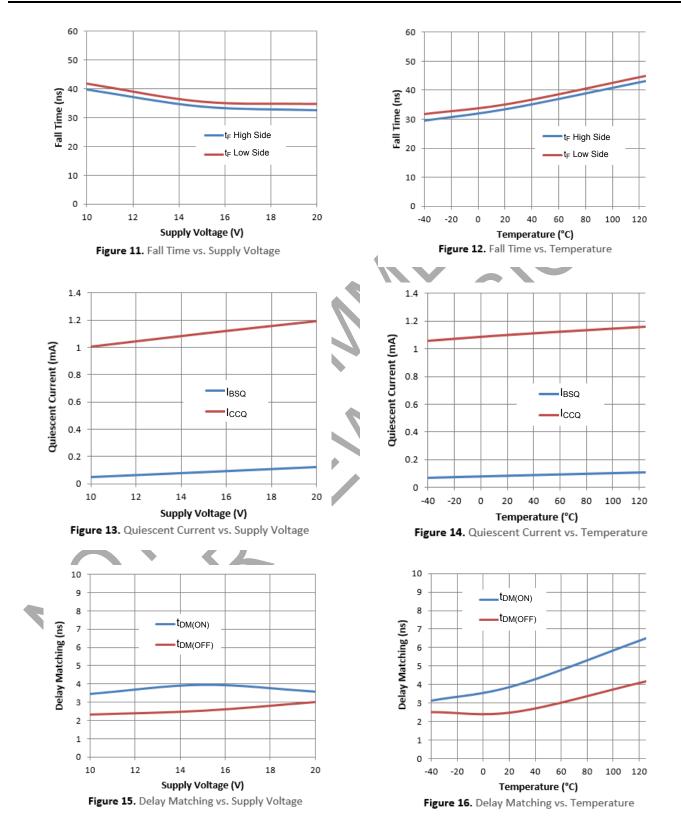


Figure 10. Rise Time vs. Temperature



# Typical Performance Characteristics (continued)





# Typical Performance Characteristics (continued)

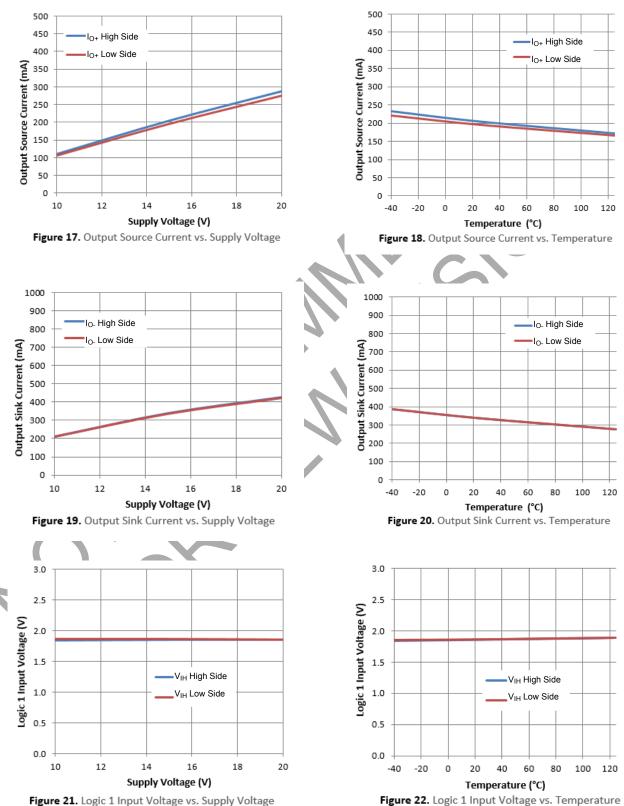
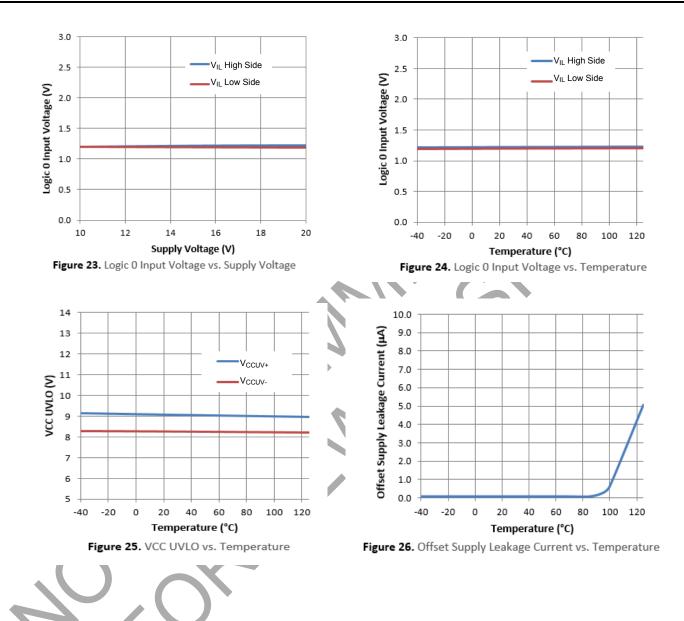


Figure 21. Logic 1 Input Voltage vs. Supply Voltage



# Typical Performance Characteristics (continued)





### **Design Notes**

Over the past decade, in white goods, there has been a transition from AC motors to brushless DC motors; correspondingly power switching is required to drive the BLDC motors. For even greater efficiency and cost reduction, 3-phase gate driver ICs are used to optimimally drive MOSFETs and IGBTs. The DGD2136, 3-Phase Half-Bridge Gate Driver IC, is a good choice for 3-phase motor applications because of ease of design, reliability, and less space used than 3 x single channel gate driver ICs.

In the inductive 3-phase motor circuit environment, MOSFET/IGBT turn-on produces significant current spikes; and the currents are the highest and the system is the noisiest during startup. In certain applications, with significant noise on the ground lines of VSS-COM (for example during startup), the DGD2136 is susceptible to the noise and can enter fault condition. And if the fault is long enough, the MCU will detect the fault situation, disable inputs and turn off the system. In effect there is a stall at startup. Figure 27 and Figure 28 show startup in a 240V refrigerator compressor application (FO\*-MCU (blue) - fault signal at MCU, COM-VSS (yellow) and VS (green) - motor voltage).

This Design Tip will provide two solutions, depending on the current sense circuit, to decrease the IC ground noise and ensure the DGD2136 does not enter fault condition and there is no stall at startup.



**Figure 27.** During startup when the current is high, COM-VSS noise is high (yellow), fault conditions occur (blue), compressor will eventually stall, 2ms/div



Figure 28. During startup, current is high, COM-VSS noise is high, fault conditions occur, compressor will eventually stall, 100us/div

# Solution 1

If the 3 phase current sensing configuration is similar to Figure 29 or Figure 30, then the best solution is to short the line between VSS and COM directly at the IC. This provides a more stable ground at the IC, and the current sense circuit operates normally (see Figures 31 and 32).

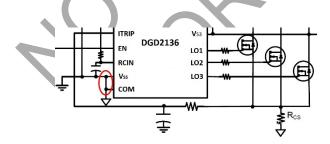


Figure 29. Shorting VSS-COM at IC for current sense configuration A

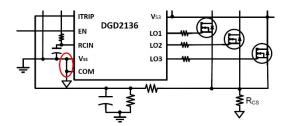


Figure 30. Shorting VSS-COM at IC for current sense configuration B



#### Design Notes (continued)

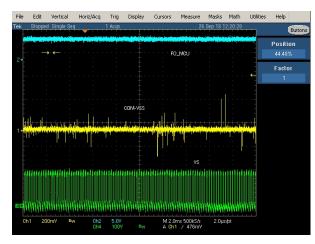


Figure 31. During startup, current is high, with shorted COM-VSS, noise is less, fault conditions do not occur, compressor will not stall, 2ms/div

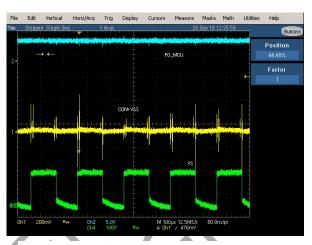
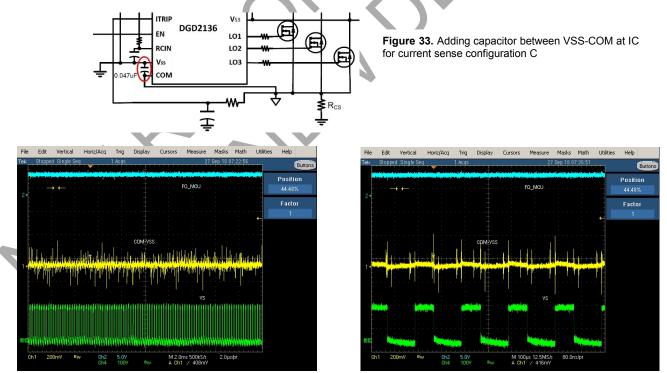


Figure 32. During startup, current is high, with shorted COM-VSS, noise is less, fault conditions do not occur, compressor will not stall, 100us/div

### Solution 2

If the 3-phase current sensing configuration is similar to Figure 33, then the best solution is to add a ceramic capacitor (0.022 to 0.1uF) between VSS and COM directly at the IC. This provides a more stable ground at the IC, and the current sense circuit operates normally (see Figures 34 and 35).



**Figure 34.** During startup current is high, with cap between COM-VSS, noise is less, fault conditions do not occur, compressor will not stall, 2ms/div

Figure 35. During startup current is high, with cap between COM-VSS, noise is less, fault conditions do not occur, compressor will not stall, 100us/div

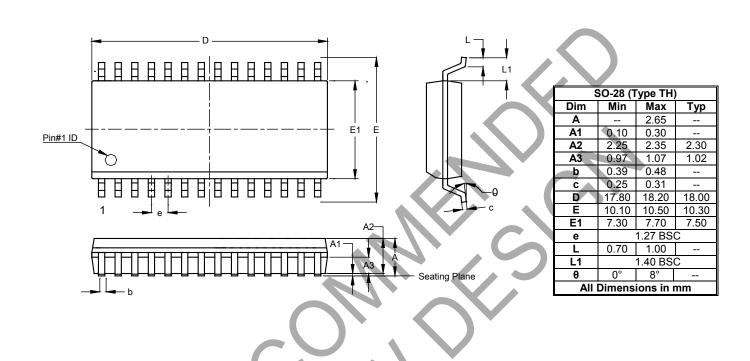
#### Summary

To improve the performance of the DGD2136 during high current operation of 3-phase motor applications, it is best to make a more stable IC ground. Depending on the current sense circuit arrangement in the 3-phase motor driver application, two solutions are provided: one that shorts the connection between COM-VSS and another is adding a ceramic capacitor between COM-VSS. In a compressor application, there were no fault conditions seen at the MCU and the COM-VSS noise was significantly less with the solutions provided.



#### **Package Outline Dimensions**

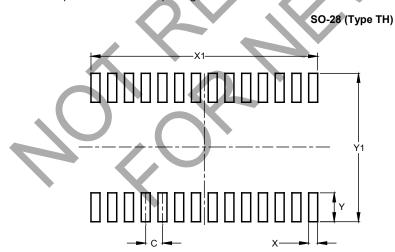
Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-28 (Type TH)

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	1.270
X	0.680
X1	17.190
Y	2.200
Y1	11.300

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.



#### IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

#### LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

- 1. are intended to implant into the body, or
- 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2019, Diodes Incorporated

www.diodes.com

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Diodes Incorporated: DGD2136S28-13